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the phosphazene compatibility enhancing resin being present in an amount of 10 to 500% by weight based on the weight of said phosphazene compound.

REMARKS

Feb 07, 2003

In the Office Action dated October 22, 2002, claims 1-13 are rejected. Referring to the Nakacho reference, the final office action stated that applicant's argument that the Nakacho reference "does not disclose the problem of incompatibility and does not propose a solution for it (is) not persuasive since instant claims do not encompass these limitations."

In view of applicant's disclosure, it is argued that the above amendment only more particularly points out and distinctly claims the subject matter of this invention. The amended claim merely clarifies the subject matter that was already present in the claims and the disclosure.

For example, the disclosure states on page 14 that ^{OK} "(B)y adding component (B) to the composition, it becomes possible to enhance compatibility between the polyamide resin (A) and the phosphazene compound (C), and prevent the occurrence of sticky surfaces of pellets or molded products due to bleed-out of the phosphazene compound (C), or the occurrence of mold deposits."

In view of the amendment and discussion above, it is respectfully submitted that the present application is in condition for allowance. A reconsideration and notice of allowance are earnestly solicited.

Applicants believe that additional fees are not required for consideration of the within Amendment. However, if for any reason a fee is required, a fee paid is

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Applicants believe that additional fees are not required for consideration of the within Amendment. However, if for any reason a fee is required, a fee paid is inadequate or credit is owed for any excess fee paid, you are hereby authorized and requested to charge Deposit Account No.: 04-1105.

Respectfully submitted,

Date: 4/7/2003

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VERSION WITH MARKINGS TO SHOW CHANGES

1. (Amended) A flame retardant resin composition comprising:

100 parts by weight of a thermoplastic polyamide resin [(A)],

1 to 100 parts by weight of a phosphazene compound [(C)], and

a phosphazene compatibility enhancing resin, consisting essentially of a
polyphenylene ether-based resin, a polystyrene-based resin or a mixture thereof, [(B)]

the phosphazene compatibility enhancing resin being present in an amount of
10 to 500% by weight based on the weight of said phosphazene compound [(C)].